

RoHS

Hazardous Element Inspection Instrument

XGT Series 電子情報製品 汚染管理弁法 CHINESE ROHS



Explore the future HORIBA

R o H S E L V C h i n e s e R o H S

The environmentally aware nations of Europe have passed common environmental regulations called

"European Directives" which have been adopted by the European Union (EU).

Directives which regulate hazardous substances contained in products are called "RoHS"

for electronics and electrical instruments and "ELV" for automotive parts.

These directives are important regulations that restrict the importation in the Europe for non compriance product

Moreover, this movement has also spread to other countries outside of Europe,

and a similar regulation (Regulation for Pollution Control of Electronics Products) was passed in China.

Currently, equipment necessary for inspecting goods in accordance with these regulations is in demand.

Moreover, it is essential that materials used in production comply with the hazardous element regulations

(RoHS/ELV) by employing lead-free solders and resins which have less of an environmental impact.

HORIBA's ecological procurement supporting instruments adhere to these regulations.

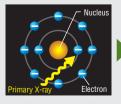






XGT-5000WR / 5700WR

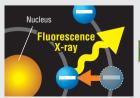
Principle of Fluorescence X-ray Generation



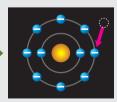
1 Absorption of primary X-ray



 $2^{\text{ An electron is knocked out by}} \\$ the primary X-ray



3 Unstable State → Energy is generated when an outer-shell electron falls back to the inner shell = Fluorescence X-ray



4 An external electron is taken in and the molecule is stabilized.

Energy of the fluorescence X-ray is characteristic of the element

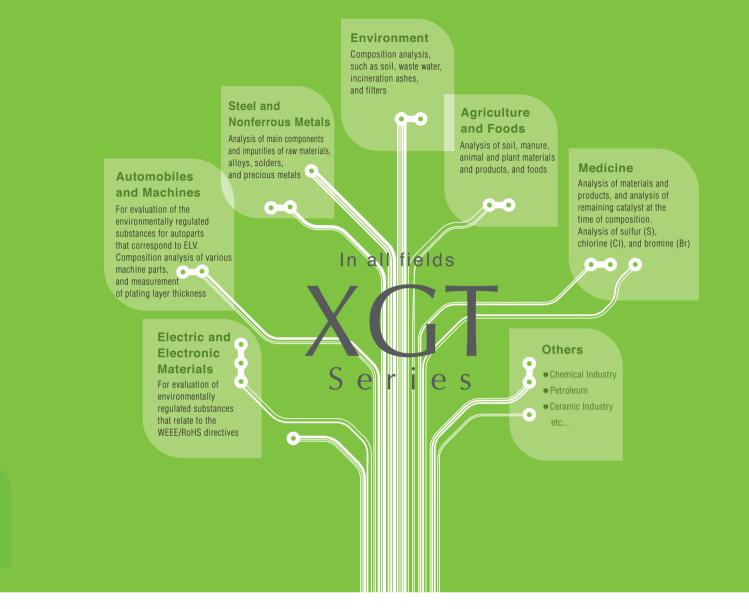
Energy difference between orbits is characteristic of the element

Qualitative

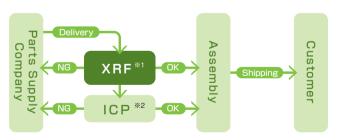
Intensity of the fluorescence X-ray

The fluorescence X-ray intensity corresponds to the element concentration within the sample

Quantitative



■Flow of Parts Management



%1 : Fluorescence X-ray analysis

*2 : Inductively-coupled-plasma emission spectrochemical analysis

■Analysis of Hazardous Elements

Hazardous Substances	Typical Examples of Measurement	
Hazaruous Substances	Screening analysis	Detailed Analysis
Cadmium (Cd)		● ICP emission spectrum analysis
Lead (Pb)	Fluorescence X-ray analysis	 ICP mass analysis
Mercury (Hg)		 Atomic absorption analysis
Hexavalent Chrome (Cr ⁶⁺)	 Fluorescence X-ray analysis (analyzing all Cr) Spot test 	● Absorptiometric analysis ● Ion Chromatography Analysis
Polybrominated biphenyl (PBB) *3	Fluorescence X-ray analysis (analyzing all Br)	• 00
Polybrominated diphenyl ether (PBDE) *3	(analyzing all Br) ●FTIR method (% order)	• GC mass analysis

※3: Only subject under the RoHS



RoHS (Restriction of the use of certain Hazardous Substances)

Restriction of the use of certain hazardous substances in electric and electronic instruments. Prohibited substances include cadmium (Cd), lead (Pb), mercury (Hg), hexavalent chrome (Cr), polybrominated biphenyl (PBB) and polybrominated diphenyl ether (PBDE).



Chinese RoHS (Regulation for Pollution Control of Electronics Products)

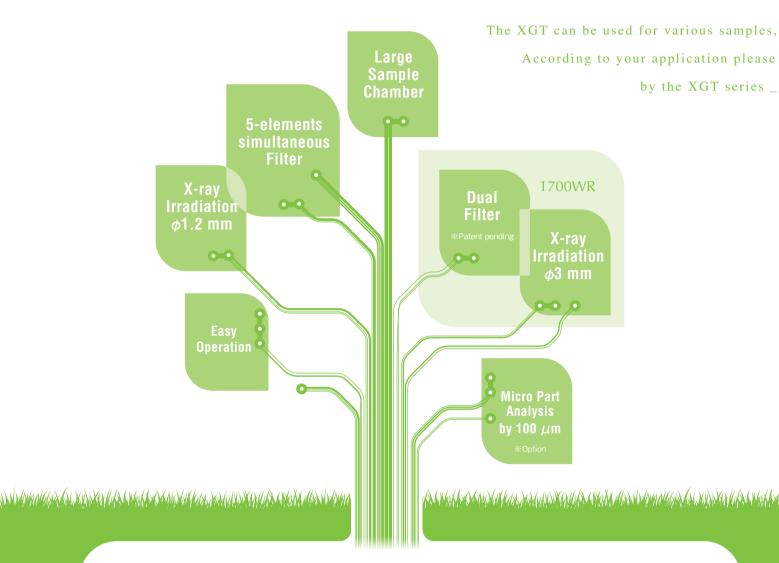
Six substances which are controlled subjects by the European RoHS for the electronic information products marketed in China are regulated. It has been enforced starting March 1, 2007 and only obligates displaying of the controlled substances at the beginning. However, an intensive administrative list will be created in the future, and the uses of the controlled substances in the products which appear in this list will be forbidden. (The products to appear in the list has not yet been determined)



ELV (End of Life Vehicles Directive)

Effective from October 21, 2000 (published in Official Journal). By the ELV, the use of four substances of cadmium (Cd), lead (Pb), mercury (Hg), and hexavalent chrome (Gr), etc. is regulated.

Point? Area? HORIBA



Point Analysis

Easy analysis because of the small X-ray irradiation diameter.

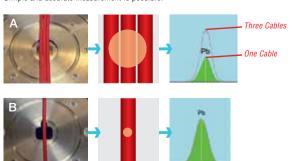


Cable covering (2 mm in diameter)

Measurement Conditions

A: Conventional instrument (irradiation diameter: ϕ 5 mm), B: XGT-1000WR (irradiation diameter: ϕ 1.2 mm)

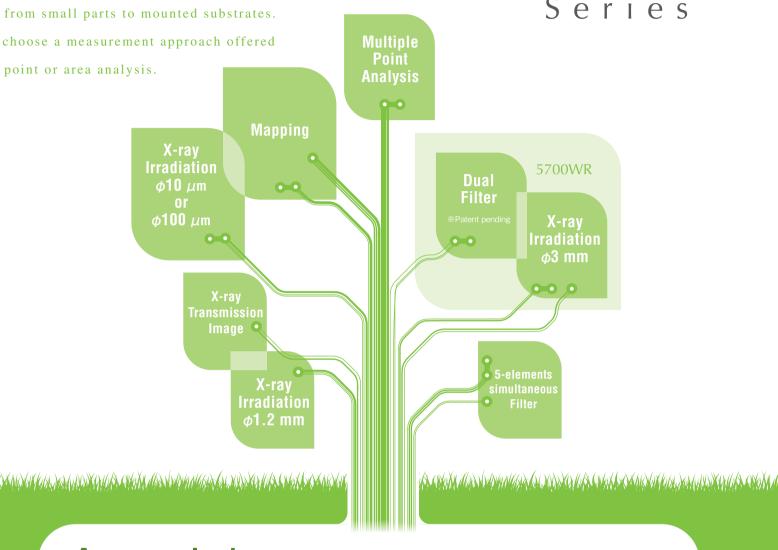
For accurate measurement it is necessary for the irradiation beam to entirely hit the sample. With a large X-ray beam narrow samples such as cable coverings must be grouped together. With the 1.2mm irradiation beam of the XGT this is not necessary. Simple and accurate measurement is possible.





offers both approaches.





Area analysis Comprehensive results with mapped images



Horiba's pH meter

Measurement Conditions

X-ray tube voltage : 50 kV X-ray tube current: 1.0 mA X-ray irradiation diameter : φ100 mm Mapping area: 12.8x12.8 mm

A conventional substrate with lead-containing solder and a substrate with lead-free solder were analyzed. From the element mapped image, it is shown that lead is not contained in the lead-free solder; however, lead is still present in the parts







Horiba's pH meter

Optical Image

X-ray Transmission Image

RGB Composition Image Ni+Pb+Cu

As seen in the photo to the right, element distribution is obvious from the RGB composite image.







5000WR Page 13

5700WR Page 13

Performance

HORIBA's original X-ray focusing technology enables high-precision and high-speed analysis.

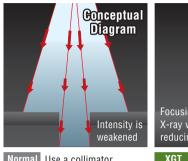
HORIBA's X-ray Focusing Technology

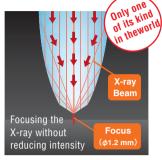
Use of the X-ray guide tube, unique to HORIBA

The XGT adopts a narrow and high-intensity X-ray system using HORIBA's original X-ray focusing element. The XGT excels in measuring time and accuracy compared with a system using an X-ray collimator.



Practical and easy to use micro-part analyzing instrument with a 100 μ m X-ray guide tube of simultaneous multiple elements (Na to U).





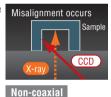
Normal Use a collimator

XGT Use an X-ray guide tube

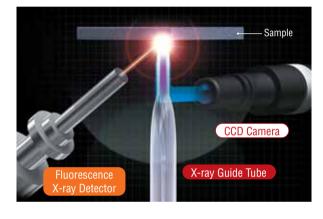
Measuring point can be reliably aligned

Because the X-ray irradiation and the CCD observation are coaxial, the measurement point will never be out of alignment. In case that the X-ray irradiating surface is

uneven caused by the sample itself or binding the samples, it may happen as shown in the figure below.

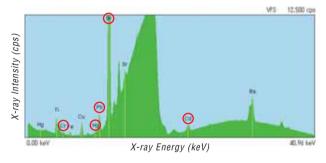


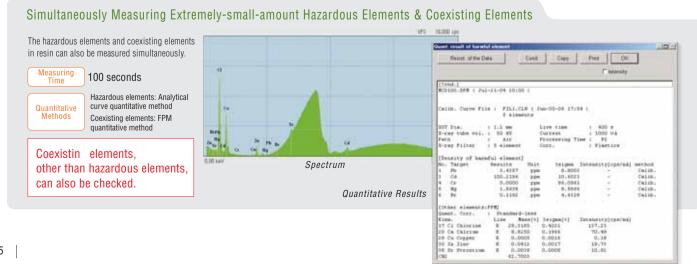




By adopting the exclusive special filter, Pb/Cd/Hg/Cr/Br can be measured simultaneously.

It is possible to obtain information on elements from X-ray energy, and know the concentration of the elements from the X-ray intensity.







Easy Operation

Place a sample while looking at the optical image

Simply place the sample directly into the sample chamber. No pretreatment is necessary if it is 1.2 mm or more.



Press the measurement button

Simply press the start button for the 5-element-simultaneous analysis. No switching of filters is necessary.



3 Measurement and displaying the results

Automatic display of quantitative window after measurement.



Determining compositions and saving the results

Automatically transmit to Excel® with one click. OK/NG determination is also possible, if in-house administrative values are registered.



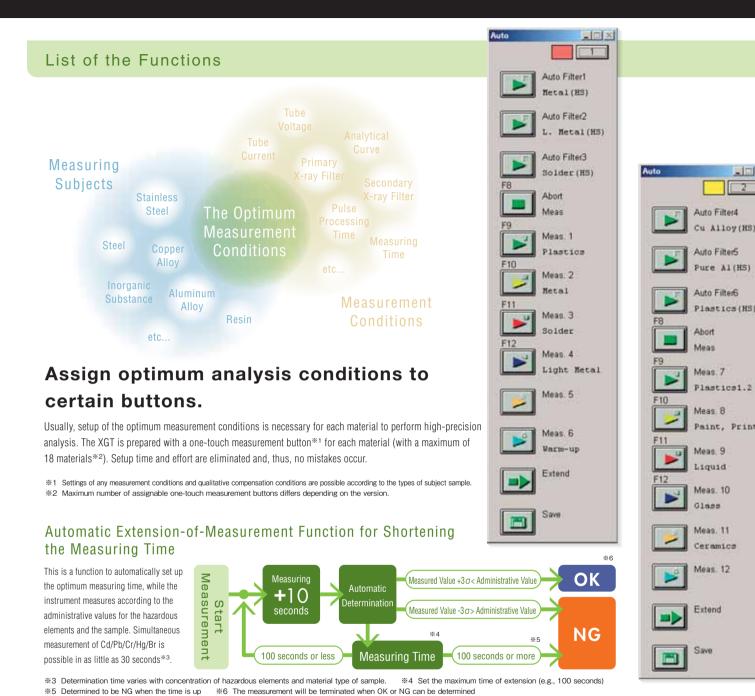
Data management and report generation is easy.

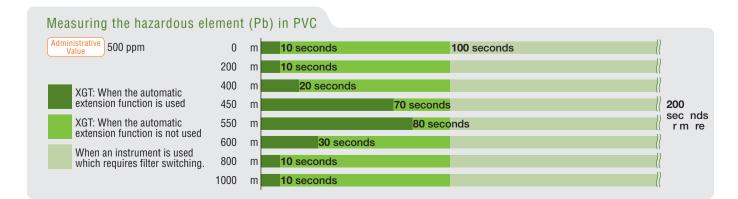
The XGT series is designed to perform reliable and quick inspection even when the user does not have special knowledge. The quantitative results are automatically displayed after the analysis, and the data is transmitted to Excel® by one click. The data is powerful for data editing. By Excel®, contents determination can be automatically performed if each user's in-house standard values are registered.

Qualitative Analysis Report
(An exclusive format can also be created with the touch of a button)

Performance

Support your analysis with well-developed functions.







Measuring Film Thickness with the Multilayer Film FPM (optional)

- Pb Measurement of a non-electrolyzed Ni plating sample -

Pb contained as a stabilizer in the non-electrolyzed Ni plating solution contaminates the Ni plating.

otep #1

A test piece (SUS plate) is Ni plated and removed to be stacked in sufficient thickness (tens of μm) for analyzing



ing foil

Sample	ICP	XGT	
		Step #1	Step #2
No.1	396	444	400 (18.6μm)
No.2	674	736	600 (19.9μm)

(Unit: mass ppm)

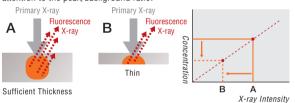
te #2

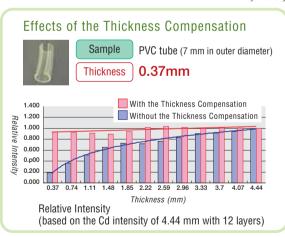
Film thickness and concentration of the plating sample is directly measured by the Multilayer Film FP method.

Layer Composition	Composition Elements	
1st layer	Ni/P/Pb	
2nd layer (bulk)	Fe	

Thickness Compensation

If the sample does not have sufficient thickness, the concentration will be calculated lower. Thickness compensation is performed by paying close attention to the peak/background ratio.

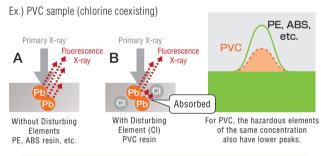


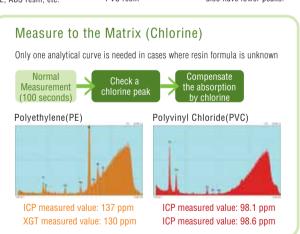


Matrix (Chlorine) Compensation

Measurement Results

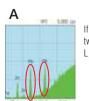
(Pb Concentration)



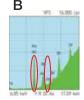


Automatic Determination of Pb - Influence on Pb by As -

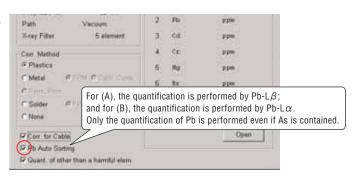
Pb-L α line and As-K α line overlap. In cases where a lot of As is contained, the automatic sorting function performs a quantification by Pb-L β .



If Pb is contained, two peaks of Pb-L α , L β will appear



Because there is no peak of L β , it can be said that the peak considered to be Pb-L α is a peak of As



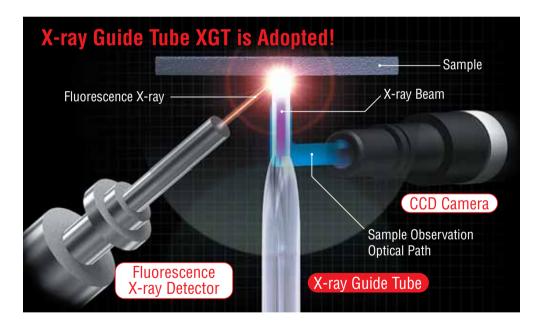




From small parts

The XGT differs in its X-ray intensity.
 The secret of high-precision and high-speed analysis.

The XGT-1000WR/1100WR adopts a narrow and high-intensity X-ray beam system using HORIBA's original X-ray focusing element. It outperforms systems using an x-ray collimator in both measuring time and accuracy.



 Pb/Cd/Hg/Cr/Br are measured simultaneously with the 5-element filter.









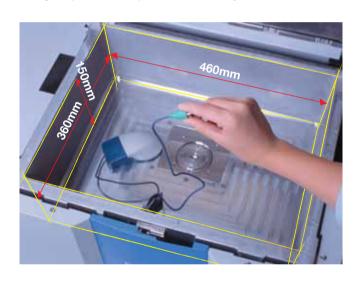
X-RAY 1.2 mi

• X-RAY 100 μ m (optional)

to large products, widely applicable.

Large sample chamber is a standard.

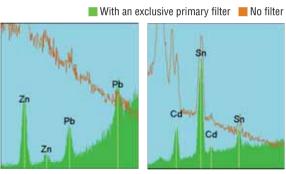
Large samples (keyboard etc.) can also be measured nondestructively by using the large sample chamber. No pretreatment is necessary.



Detection sensitivity is considerably increased

By using HORIBA's original 5-element-simultaneous filter, five elements may be detected with sufficient sensitivity.

5-element-simultaneous measurement



Lead (Pb) Spectrum

Cadmium (Cd) Spectrum

Application

Analyzing a wire harness



Wire harness

Measuremen

Irradiation diameter: ϕ 1.2 mm

- 1. Directly placing a sample into the sample chamber.
- 2. With the 1.2 mm X-ray irradiation diameter, a small part (e.g., wire harness) can also be easily measured.
- 3. Anyone can obtain accurate measurement results.

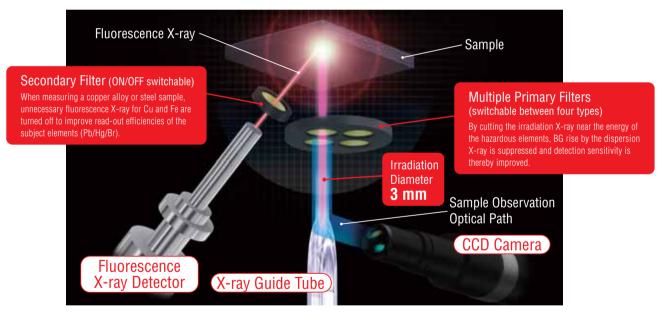
*Cable securing kit (optional) is used in the photo.



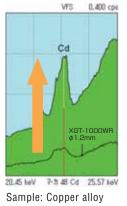


New optical system for analyzing hazardous elements in metals with high sensitivity

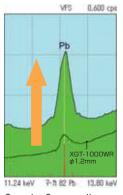
The XGT-1700WR uses an x-ray guide tube to generate a 3 mm irradiation beam. Improved detection sensitivity is realised through the use of a dual filter (primary and secondary filters). The XGT is the first XRF system to use a dual filter for WEEE/RoHS and ELV applications.



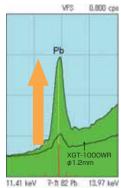
Improvement in **Sensitivity**



Concentration: Cd97 ppm



Sample: Copper alloy Concentration: Pb511 ppm



Sample: Solder Concentration: Pb890 ppm







- X-RAY 3 mm
- X-RAY 1.2 mm (optional)
- X-RAY 100 μ m (optional)

Sensitivity is greatly improved by adopting the new optical system!

Measurement Data

•In Brass: Cd 41 ppm, Pb 495 ppm (repeatedly-measured example) X-ray irradiation diameter: φ3 mm Measuring time: 300 seconds

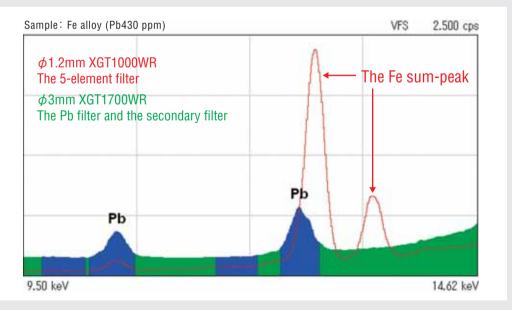
Number of Measurements	Cd Concentration (ppm)	Pb Concentration(ppm)
1	37.3	509.2
2	41.2	488.4
3	40.2	492.9
4	46.8	486.5
5	43.3	482.6
Average Value	41.8	491.9
Standard Deviation	3.6	10.3
CV	8.5%	2.1%

•In electrolyzed Ni plating (14.3 μm): Pb 700 ppm (repeatedly-measured example)
X-ray irradiation diameter: φ3 mm Measuring time: 300 seconds

Number of Measurements	Pb Concentration(ppm)	Film Thickness(μ m)
1	735.7	13.7
2	708.8	14.4
3	750.0	13.5
4	707.8	13.9
5	693.0	13.0
Average Value	719.1	13.7
Standard Deviation	23.2	0.5
CV	3.2%	3.7%

Application

Effect of Pb/secondary filter (Fe alloy sample)



The Pb filter and the secondary filter reduce background and the Fe sum-peak is also decreased, while the Pb-L β line can also be checked.



• X-RAY 100 μm or 10 μm







5700WR

- X-RAY 3 mm
- X-RAY 100 μm or 10 μm

Welcome to the 10

• The secret of high-speed and detailed measurement, which is only possible with the XGT.

The use of HORIBA's original X-ray focusing element provides a narrow and high intensity X-ray beam. High speed measurement of micro parts is easily possible, in comparison with conventional systems using X-ray collimators. Moreover the optional liquid nitrogen free detector which uses a pulse tube freezer provides complete ease of use (5100WR/5710WR). Safe and high precision analysis is realised.



From one point to an entire area, the analytical possibilities are endless.

Hazardous element distribution of an electrical component or a printed circuit board is shown at a glance using the mapping function. Furthermore, the high-precision measurement of the hazardous elements is possible by the automated multiple point analysis function. If switched to the X-ray focusing guide tube designed for analysis of micro parts, fluorescence X-ray analysis and transmission X-ray analysis are also possible with 10 µm resolution. Foreign objects and defects can be analysed quickly and simply.



um world!



Awarded the Good Design Award Awarded R&D100 Award of U.S. R&D Magazine

Application

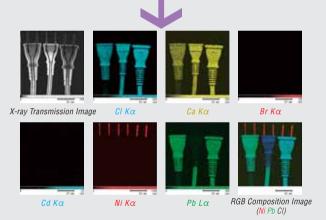


Mapping Analysis

Sample

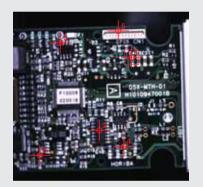
Measurement Conditions

X-ray tube voltage: 50 kV X-ray tube current : 1.0 mA X-ray irradiation diameter : ϕ 100 μ m Mapping area : 90.211x90.211 mm



Multiple Point Analysis of a Printed Circuit Board

Multiple points specified from the optical image can be continuously measured.



Multiple Point Automatic Analysis



Conventional Product

Analysis of the Printed Circuit Board

- Comparison of the conventional product and Pb-free product -

Measurement Conditions

X-ray tube voltage : 50 kV X-ray tube current : 1.0 mA

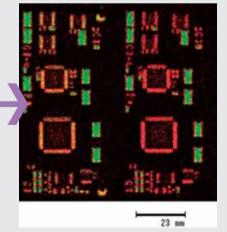
X-ray irradiation diameter : ϕ 1.2 mm (with a primary X-ray filter)

Measuring time: 1000 seconds Mapping area: 93x93 mm



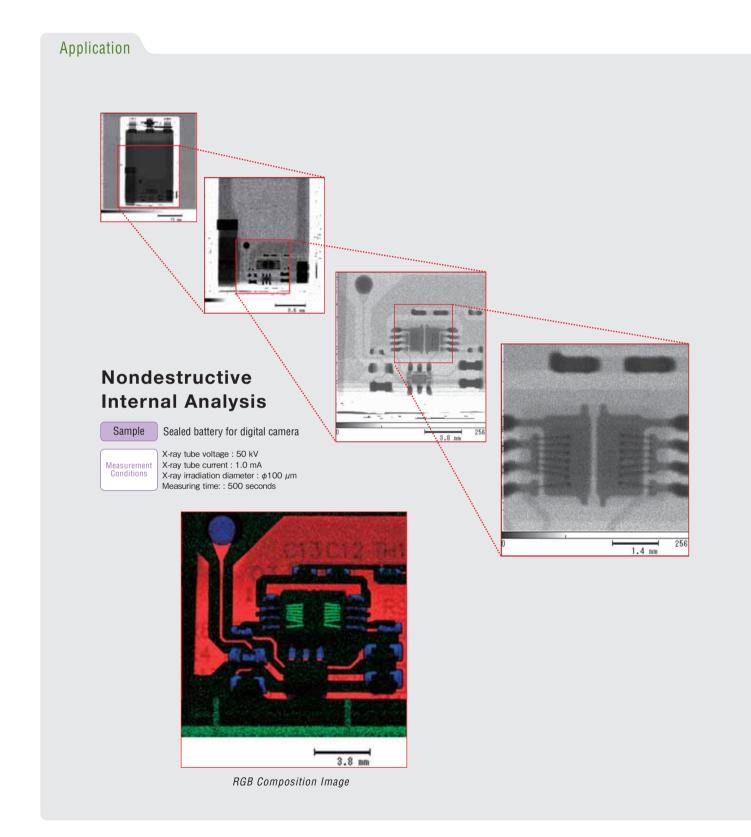


Pb Lα

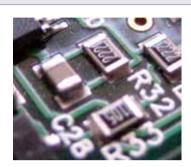


Red: Sn, Green: Pb (Composition Image)

Examples of 5000 series.







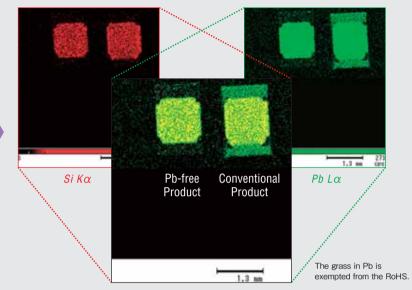
Analysis of Chip Resistor

 Identifying parts exempted from the regulations -

Sample

Chip Resistor

Measurement Conditions X-ray tube voltage : 50 kV X-ray tube current : 1.0 mA X-ray irradiation diameter : ϕ 10 μ m Measuring time : 1000 seconds Mapping area : 5x5 mm



Red: Si, Green: Pb (Composition Image)
Yellow: Sn + Pb

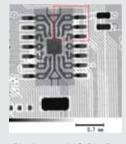


Analysis of a Printed Circuit Board

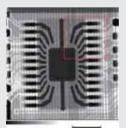
Sample

Printed circuit board

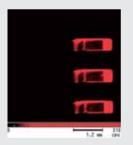
Measurement Conditions X-ray tube voltage : 50 kV X-ray tube current : 1.0 mA X-ray irradiation diameter : ϕ 10 μ m Measuring time : 1000 seconds Mapping area : 99.840x99.840 mm



Pb-detected IC Pin Part



Pb-undetected IC Pin Part





Sn Kα



Pb Lα



Pb $L\alpha$

Line up of the Large and Supersized sample chamber models

Large and unwieldy samples can now be measured with the same performance and ease of use. Previously it was necessary to cut or pretreat such samples prior to analysis. These models can be configured for WEEE/RoHS/ELV directives as with the other XGT systems.









- X-RAY 1.2 mm*
- X-RAY 100 μm*
- X-RAY 10 μm*

Large Sample \
Chamber Model /

- ■Sample size 500 mm(W) x350 mm(D) x85 mm(H)
- ■Mapping size 200 mm x200 mm













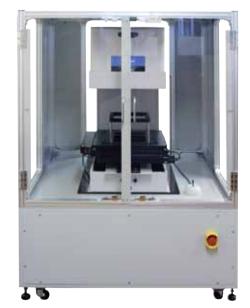
- X-RAY 1.2 mm*
- X-RAY 100 μm*
- X-RAY 10 μm*

Two are selected from *.

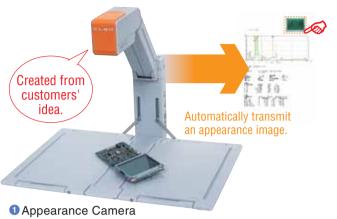
- ✓ Supersized Sample `

 Chamber Model ✓
- ■Sample size 500 mm(W) x500 mm(D) x300 mm(H)
- ■Mapping size 200 mm x200 mm





Various Support Accessories



In combination with the XGT-1000WR series it is possible to automatically transmit and save a photograph of the sample to the instrument PC. The image can the be used within the report generated from the measurement results.



2 PET Cell
This is convenient for liquid, powder, and microsample analysis.



This is convenient for analyzing a large amount of samples.

4 Teflon Cell

3 Disposable Cell

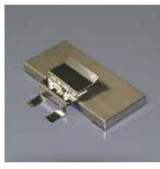
This is convenient for sample analysis of an organic solvent, etc.



5 Powder Pressing Machine Pressing of a powder sample is possible using this electric press machine



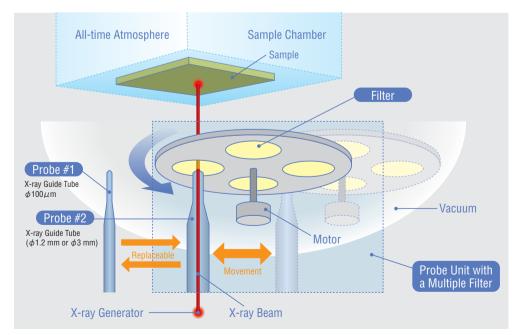
6 Sample Holding Kit
This is an exclusive tool for holding a sample with a complicated shape.



Cable Holding Kit
This is an exclusive tool useful for holding cables.



3 Large X-ray ON light The light illuminates during X-ray irradiation (during analysis).



Multiple Filter

The XGT is equipped with the hazardous-5-element simultaneous analysis filter*, which is unique in the industry for fast analysis of all five RoHS/ELV elements.
Further, a multiple-filter unit allows a number of filters to be switched, for analysis of specific elements, and general purpose analysis (Na-U). *As of March, 2005

Specification



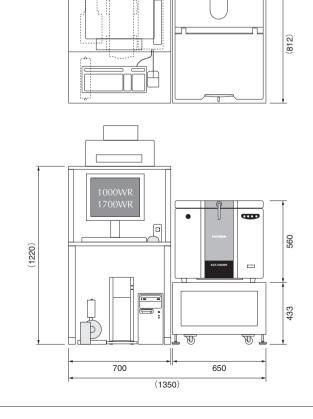






Measurement Principle		Energy-dispersion-type Fl	uorescence X-ray Analysis	
Measurable Elements		Si to U and Na	Si to U and Na to U (optional)	
Sample Din	nensions	Max 460 x 360 mi	m (Height 150 mm)	
Sample		Plastic, metal, paper, and I	iquids such as paint and ink	
Sample Chamber Atmosphere		Atmosphere		
XGT Element Spatial Resolution		1.2 mm, and additional 100 µm (optional)	Standard 3 mm, or choose from 1.2 mm and 100 µm (optional)	
X-ray Tube		50 kV/1 mÅ, Rh Target		
Vacuum Probe		Optional		
Primary X-r	ray Filter	For 5-element-simultaneous analysis(Cd/Pb/Cr/Hg/Br),Automatic switching between maximum of four types, such as for Cd/exclusive for Cr, Cl/for P (no filter) (optional)	3 mm irradiation diameter: automatic switching between four types; 1.2 mm irradiation diameter: 5-element-simultaneous analysis filter or no filter, 100 µm irradiation diameter: no filter	
Secondary X-ray Filter			Standard equipment for hazardous-elements-in-metal high-sensitivity measurement (ON/OFF automatic switching)	
Detector		Nitrogen cooling type of 3 liter (1000WR, 1700WR) high-purity Si detectors		
Stage				
Sample Chamber		460×360	×150 mm	
Optical Ima	Optical Image Observation by 50X magnification (coaxial) Entire sample image (optional)			
Analysis	Qualitative	Automatic qualitative function, BG display, ROI classification by color, and matching function		
Functions Quantitative		FPM, analytical curve, hazardous elements (CI compensation, thickness compe	ensation, and cable compensation), and measurement-function short-cut function	
	Measurement Sequence	Condition setting → measurement → quantitative analysis, all with one button		
Multilayer Film		Multilayer film FPM (optional)		
Data Management (optional)		Excel® data management software, ecological procurement supporting software, and an inspection report output		
Power Supply		AC100 V、120 V、220 V、240 V ±10%、50/60 Hz		
Power Consumption		1.3 kVA or lower (XGT-1000WR, 1700WR)		
Instrument Weight		approx. 200 kg (XGT-1000WR, 1700WR)		
Outer Dimensions		Analyzing Unit: 610 (W)x750 (D)x500 (H) mm, Signal Processing Unit: 220 (W)x500 (D)x480 (H) mm		
Dimensional Outlines				

1000WR/1700WR



(Japanese Patent No. 2900086) The function which specifies a measuring point of the fluorescence X-ray analysis based on the optical observation image, and irradiates the primary X-ray at this single point is owned



Energy-dispersion-type Fluorescence X-ray Analysis

Na to U (in sample atmosphere)

Max 350 mm x 400 mm x 40 mm / Max 100 mm x 100 mm

Plastic, metal, paper, and liquids such as paint and ink

Atmosphere

10 μm+1.2 mm or 100 μm+1.2 mm

10 μm+3 mm or 100 μm+3 mm

50 kV/1 mA, Rh Target

Standard equipment

For 5-element-simultaneous analysis(Cd/Pb/Cr/Hg/Br),Automatic switching between maximum of four types, such as for Cd/exclusive for Cr, Cl/for P (no filter) (optional)

3 mm irradiation diameter: automatic switching between four types,
10 µm irradiation diameter: no filter, 100 µm irradiation diameter: no filter
Standard equipment for hazardous-elements-in-metal high-sensitivity measurement (ON/OFF automatic switching)

Fluorescence X-ray detector: Nitrogen cooling type of 3 liter (5000WR, 5700WR) high-purity Si detectors

Transmission X-ray detector: Nal (TI) scintillator

100 mm×100 mm (maximum mapping area), 200 mm×200 mm (optional)

400×350×40 mm (Additional special order is possible)

Entire image: 100 x 100 mm (Standard: 400,000 pixels, Optional: 2 million pixels)

Detailed image: Observation by 100X magnification (coaxial)

Automatic qualitative function, BG display, ROI classification by color, and matching function

FPM, analytical curve, hazardous elements (CI compensation, thickness compensation, and cable compensation), and measurement-function short-cut function

Condition setting → measurement → quantitative analysis, all with one button (transplanted function from XGT-1000WR)

Multilayer film FPM (optional)

Excel® data management software, ecological procurement supporting software, and an inspection report output

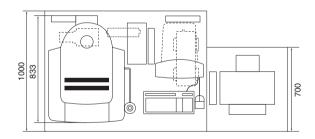
AC100 V, 120 V, 220 V, 240 V ±10%, 50/60 Hz

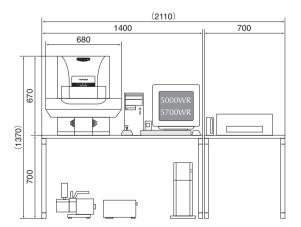
1.3 kVA or lower (XGT-5000WR, 5700WR)

approx. 280 kg (XGT-5000WR, 5700WR)

Analyzing Unit: 680 (W)x833 (D)x670 (H) mm (XGT-5000WR, 5700WR)

5000WR/5700WR





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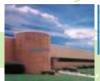
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